

Application Data Sheet

Application Information

Application Type:: Reissue
Subject Matter:: Utility
Suggested classification::
Suggested Group Art Unit::
CD-ROM or CD-R?:: None
Computer Readable Form (CRF)?:: No
Title:: PROCESS FOR MANUFACTURING
SEMICONDUCTOR DEVICE AND
SEMICONDUCTOR WAFER
Attorney Docket Number:: 069974-0143
Request for Early Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure:: 4C
Total Drawing Sheets:: 4
Small Entity?:: No
Petition included?:: No
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Keiichiro
Family Name:: Kata

City of Residence:: Tokyo
Country of Residence:: Japan
Street of mailing address::
Tokyo,
Country of mailing address:: Japan

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Shinichi
Family Name:: Chikaki
City of Residence:: Tokyo
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Correspondence Information

Correspondence Customer Number:: 22428
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Representative Information

Representative Customer Number::	22428	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Reissue of	5,844,304	12/01/1998

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	6-237653	09/30/1994	Yes

Assignee Information

Assignee name:: NEC Corporation